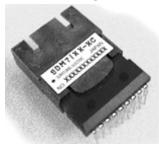
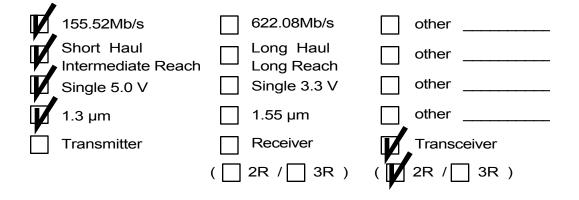
Specification: TS-S97D022C Date: August, 2000





# Technical Specification for Optical Transceiver Module

# <u>SDM7101-XC</u> <u>SDM7101-GC</u>





Sumitomo Electric reserves the right to make changes in this specification without prior notice.

**#Safety Precaution** Symbols This specification uses various picture symbols to prevent possible injury to operator or other persons or damage to properties for appropriate use of the product. The symbols and definitions are as shown below. Be sure to be familiar with these symbols before reading this specification.

| Marning Wrongoperation without following this instruction may lead to human deathor serious injury.             |
|---|
| <b>A</b> Caution Wrongoperation without following this instruction may lead to human injury or property damage. |
| Example of picture symbols of indicates prohibition of actions. Action details are explained thereafter.        |
| (SDM7101-XC,SDM7101-) indicates compulsory actions or instructions. Action details are explained thereafter.    |

## 1. General

SDM7101-XC / SDM7101-XC-W is a series of compact and high speed performance digital optical transceiver module ideally designed for versatile high speed network applications. 1300nm high speed InGaAsP FP-LD and InGaAs PIN-PD are provided as a light source and a detector, respectively. Transceiver module has PC board mountable package with electrical and optical interfaces.

| * Data Rate<br>* Duty Cycle<br>* Power Supply Voltage<br>* Electrical Interface<br>* Fiber Coupled Power<br>* Sensitivity<br>* Connector Interface | 155.52Mbps,NRZ<br>50%<br>Single+5.0V<br>PECL<br>-8 ~ -15dBm (Typ11dBm) for SMF<br>~ -34dBm (Typ38dBm)<br>SC Duplex Connector |
|--|--|
| The features of SDM7101-XC / S<br>* Features Low Pow   | DM7101-XC-W are listed below.<br>werConsumption  |
|  | ofile (9.8mm Max) Plastic Molded Package   |
|  | purcedFootprint  |
| -  | Incooled Laser with Automatic Power Control IC   |
| Receiver W   | lass 1 Laser Product (IEC 825-1 and FDA 21 CFR 1040.10 and 1040.11)<br>/ide Dynamic Range<br>ignal Detect (FLAG) Function    |

## 2. Block Diagram

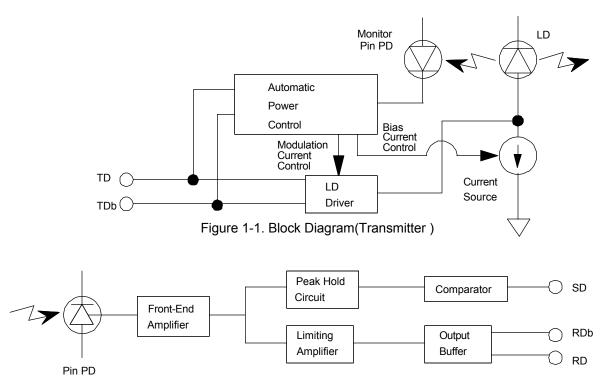


Figure 1-2. Block Diagram(Receiver)

## 3. Package Dimension

### All dimensions are in mm.

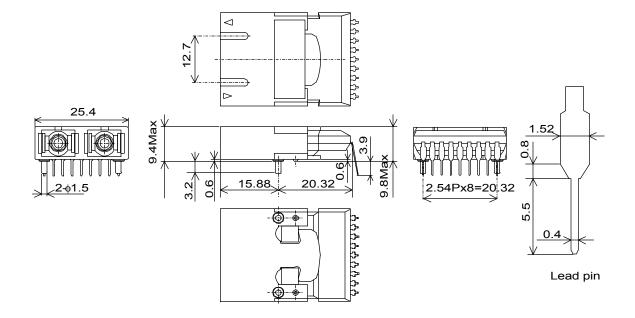


Figure2-1. Outline Dimensions (SDM7101-XC)

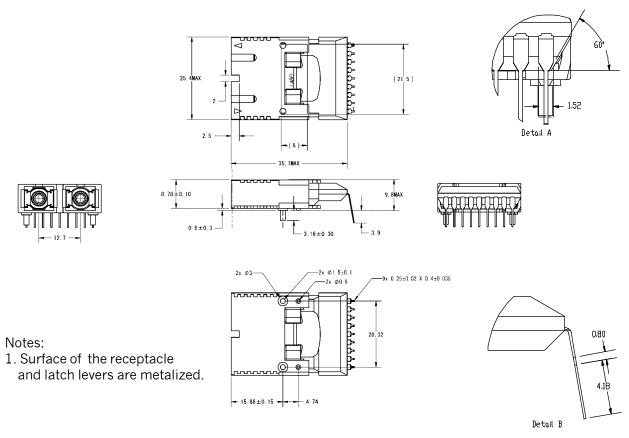


Figure2-2. Outline Dimensions (SDM7101-GC-ZN / SDM7101-GC-ZW)

### All dimensions are in mm.

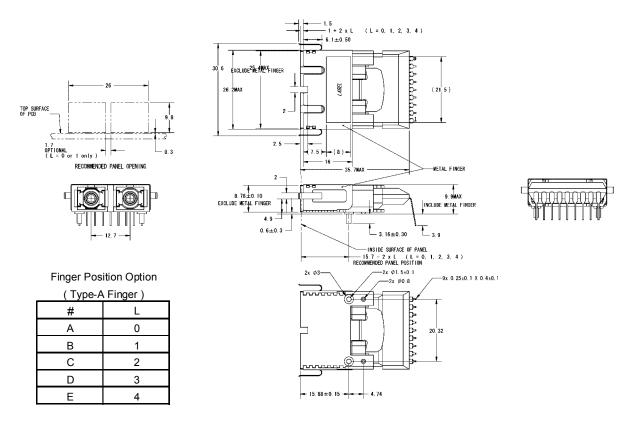


Figure2-3. Outline Dimensions (SDM7101-GC-#N / SDM7101-GC-#W)

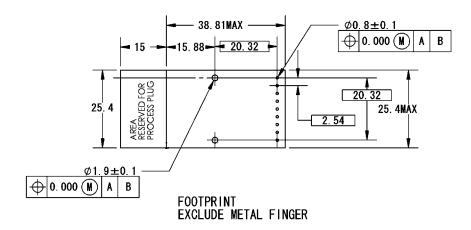


Figure2-4.RecommendedFootprint

|  | <b>≜</b> Caution  |
|--|---|
| Do not disassemble this product. Otherwis<br>Handle the lead pins carefully. Use assisti | se, failure, electrical shock, overheating or fire may occur.<br>ng tools or prospective aids as required. A lead pin may injure skin or human body |
| (SDM7101-XC,SDM7101-XC)  | - 4 / 9 -   |

## 4. Pin Assignment

| No. | Symbol   | Function  |
|-----|----------|---|
| 1   | Veerx    | Power Supply (-) for Receiver : Connected to GND      |
| 2   | RD       | Differential Data Output (Positive)                   |
| 3   | RDb      | Differential Data Output (Negative)                   |
| 4   | FLAG(SD) | FLAG (Signal Detect)                                  |
| 5   | Vccrx    | Power Supply (+) for Receiver : Connected to +5.0V    |
| 6   | Vcctx    | Power Supply (+) for Transmitter : Connected to +5.0V |
| 7   | TDb      | Transmitter Differential Data (Negative)              |
| 8   | TD       | Transmitter Differential Data (Positive)              |
| 9   | Veetx    | Power Supply (-) for Transmitter : Connected to GND   |

## 5. Absolute Maximum Ratings

| Parameter                    | Symbol  | min. | Max     | Unit | Note |
|------------------------------|---------|------|---------|------|------|
| Storage Case Temperature     | Ts      | -40  | 85      | О°   | 1    |
| Operating Case Teperature    | Тс      | 0    | 70      | С°   | 1, 2 |
|                              |         | -40  | 85      | О°   | 1, 3 |
| Supply Voltage               | Vcc-Vee | 0.0  | 6.0     | V    | 4    |
| Input Voltage                | Vi      | Vee  | Vcc+0.5 | V    | 5    |
| Lead Soldering (Temperature) |         |      | 260     | С°   | 6    |
| (Time)                       |         |      | 10      | sec. |      |

Note 1. No condensation allowed. 2. SDM7101-XC 3. SDM7101-XC-W 4. Vcc>Vee, Vcc=+5.0V, Vee=GND

5. TD, TDb 6. Measured on lead pin at 2mm (0.079in.) off the package bottom

## 🛆 Warning

Use the product with the rated voltage described in the specification. If the voltage exceeds the maximum rating, overheating or fire may occur.

## ▲ Caution

Do not store the product in the area where temperature exceeds the maximum rating, where there is too much moisture or dampness, where there is acid gas or corrosive gas, or other extreme conditions. Otherwise, failure, overheating or fire may occur.

0

### 6. Electrical Interface

(Unless otherwise specified,  $Vcc_{TX}$ -Vee<sub>TX</sub> =  $Vcc_{RX}$ -Vee<sub>RX</sub> = 4.75 to 5.25 V and all operating temperature shall apply.)

#### 6-1.Transmitterside

| Para                  | meter    | Symbol              | min.                    | Тур. | Max.                    | Unit  | Note |
|-----------------------|----------|---------------------|-------------------------|------|-------------------------|-------|------|
| Supply Voltage        |          | <b>Vсстх-Vеет</b> х | 4.75                    | 5.00 | 5.25                    | V     |      |
| Supply Current        |          | ldtx                |                         | 70   | 150                     | mA    | 1    |
| Input Voltage         | High     | Vih                 | Vcc <sub>TX</sub> -1.17 |      | Vcc <sub>TX</sub> -0.73 | V     | 2    |
| TD, TDb               | Low      | Vil                 | Vccтx-1.95              |      | Vсстх-1.45              |       |      |
| Input Current         | High     | lih                 | -10                     |      | 150                     | μA    | 2    |
| TD, TDb               | Low      | lil                 | -10                     |      | 10                      |       |      |
| Signal Input Rise / F | all Time |                     |                         |      | 1.6                     | nsec. | 3    |

Note 1. Input bias current is not included. 50% duty cycle data. 155.52Mbps 2. VccTX-VeeRX=5.0V, Tc=25°C 3. 20~80%

#### 6-2. Receiver side

| Parameter                    |             | Symbol      | min.                    | Тур. | Max.                    | Unit | Note |
|------------------------------|-------------|-------------|-------------------------|------|-------------------------|------|------|
| Supply Voltage               |             | Vccrx-Veerx | 4.75                    | 5.00 | 5.25                    | V    |      |
| Supply Current               |             | Idrx        |                         | 60   | 110                     | mA   | 1    |
| Data & SD                    | High        | Voh         | Vcc <sub>RX</sub> -1.03 |      | Vcc <sub>RX</sub> -0.88 | V    | 2    |
| Output Voltage               | Low         | Vol         | Vccrx-1.81              |      | Vccrx-1.62              |      |      |
| Data Rise / Fall Time of Out | tput Signal | Trd / Tfd   |                         |      | 1.6                     | nsec | 3    |
| SD Assert Time               |             | Sa          |                         |      | 100                     | μsec | 4    |
| SD Deassert Time             |             | Sd          |                         |      | 350                     | μsec | 4    |

Note 1. Output current is not included. 50% duty cycle data, 155Mbps, NRZ

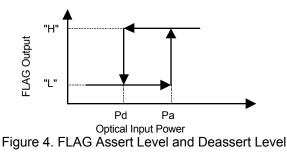
Note 2. Vccrx=+5.0V, Tc=25°C, Output load resistance

RI=50 $\Omega$  to Vccrx-2V for RD, RDb and SD.

Note 3. 20 ~ 80%

Note 4. Please refer to Figure 4

Note 5. 50% duty cycle data, 155Mbps, PRBS2<sup>23</sup>-1, NRZ, Pin = -34 ~ -8dBm



7. Optical Interface (Unless otherwise specified, Vcc-Vee = 4.75 to 5.25 V and all operating temperature shall apply.) 7-1.Transmitterside

#### Parameter Symbol Тур. Max. Unit Note min. Average Output Power to SMF Pos -15.0 -11.0 -8.0 dBm 1 Extinction Ratio Er 8.2 dB 1 Center Wavelength 1261 1360 λc nm Spectral Width (RMS) Δλ 7.7 nm Eye Mask for Optical Output Refer to Figure 5

Note 1. Measured at 155.52Mbps PRBS2^23-1, 50% duty cycle data, NRZ

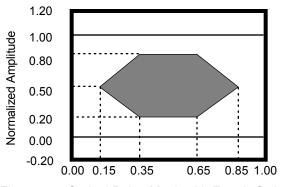


Figure 5. Optical Pulse Mask with Fourth Order Bessel-Thomson Filter Specified in ITU-T G.957

Relation between Input Signal and Optical Output Signal

| - |              |      |                       |  |  |  |
|---|--------------|------|-----------------------|--|--|--|
|   | Input Signal |      | Optical Output Siganl |  |  |  |
|   | TD           | TDb  |                       |  |  |  |
|   | High         | Low  | ON (High)             |  |  |  |
|   | Low          | High | OFF (Low)             |  |  |  |
|   | High         | High | Undefined             |  |  |  |
|   | Low          | Low  | Undefined             |  |  |  |

🛆 Warning Do not look at the laser beam projection area (e.g. end of optical connector) with naked eyes or through optical equipment while the power is supplied to this product. Otherwise, your eyes may be injured.

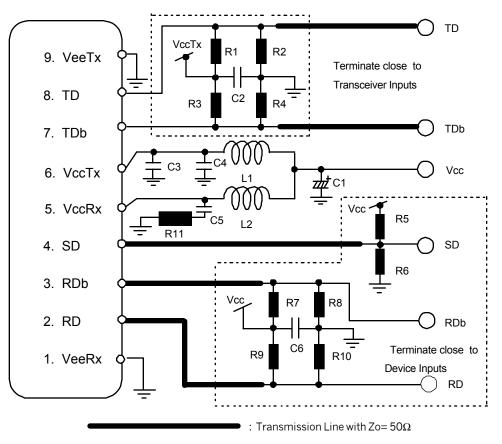
#### 7-2. Receiver side

| Parameter           | Symbol | min. | Тур. | Max.  | Unit | Note |
|---------------------|--------|------|------|-------|------|------|
| Center Wavelength   | -      | 1261 |      | 1580  | nm   |      |
| Minimum Sensitivity | Pmin   |      |      | -34.0 | nm   | 1, 2 |
| Overload            | Pmax   | -8.0 |      |       | nm   | 1, 2 |
| Flag Assert Level   | Pa     | -48  | -37  | -34   | dBm  | 2    |
| Flag deassert Level | Pd     | -49  | -40  | -34   | dBm  |      |

Note 1. BER=10^-10, 2. Measured at the bit rate of 155.52Mbps, PRBS 2^23-1, NRZ

Note 2. 50% duty cycle data

## 8. Recommended Inteface Circuit



$$\begin{split} R1 = R3 = R5 = R7 = R9 = 82\Omega \ , \ R2 = R4 = R6 = R8 = R10 = 130\Omega \ , \ R11 = 10\Omega \\ C1 = 100 \ \mu\text{F}, \ C3 = 2200 \ \text{pF}, \ C2 = C6 = 0.1 \ \mu\text{F}, \ C4 = C5 = 1 \ \mu\text{F} \\ L1, \ L2: \ \text{Ferrite Bead} \ \ ZBF \ 253D \cdot 00 \ (TDK) \end{split}$$

Figure 6 Recommended Interface Circuit

## 9. Reliability Test

| Bellcore TA | -NWT-000983 Is   | sue 2, December 19 | 93                         |         |    |   |       |     |
|-------------|------------------|--------------------|----------------------------|---------|----|---|-------|-----|
| Heading     | Test             | Reference          | Condition                  | Samplin | ng |   | SEI F | lan |
|             |                  |                    |                            | LTPD    | SS | С | SS    | F/C |
| Mechanica   | Mechanical       | MIL-STD-883        | Condition B                |         |    |   |       |     |
| Integrity   | Shock            | Method 2002        | 5 times/axis               |         |    |   |       |     |
|             |                  |                    | 500G, 1.0 ms               | 20%     | 11 | 0 |       |     |
|             |                  |                    | 1,500G, 0.5ms              | 20%     | 11 | 0 | 11    | 0   |
|             | Vibration        | MIL-STD-883        | Condition A                | 20%     | 11 | 0 | 11    | 0   |
|             |                  | Method 2007        | 20 G                       |         |    |   |       |     |
|             |                  |                    | 20-2,000 Hz                |         |    |   |       |     |
|             |                  |                    | 4 min/cycle; 4 cycles/axis |         |    |   |       |     |
|             | Thermal Shock    | MIL-STD-883        | ΔT=100°C                   | 20%     | 11 | 0 | 11    | 0   |
|             |                  | Method 1011        |                            |         |    |   |       |     |
|             | Solderability    | MIL-STD-883        | (steam aging not required) | 20%     | 11 | 0 | 11    | 0   |
|             |                  | Method 2003        |                            |         |    |   |       |     |
|             | Fiber Pull       |                    | 1 Kg; 3 times;5sec.        | 20%     | 11 | 0 |       |     |
|             |                  |                    | 2 Kg; 3 times; 5sec.       | 20%     | 11 | 0 |       |     |
| Endurance   | Accel. Aging     | (R)-453            | +85C; rated power          |         |    |   |       |     |
|             | (High Temp.)     | Section 5.18       | >5,000hrs.                 |         | 25 |   | 25    | 0   |
|             |                  |                    | >10,000hrs.                |         | 10 |   |       |     |
|             | High Temp.       |                    | max. storage T (T=85°C)    | 20%     | 11 | 0 |       |     |
|             | Storage          |                    | >2,000                     |         |    |   |       |     |
|             | Low Temp.        |                    | min. storage T (T=-40°C)   | 20%     | 11 | 0 | 11    | 0   |
|             | Storage          |                    | >2,000                     |         |    |   |       |     |
|             | Temperature      | Section 5.20       | - 40°C to +85°C            |         |    |   |       |     |
|             | Cycling          |                    | 400 times pass/fail        | 20%     | 11 | 0 |       |     |
|             |                  |                    | 500 times for info.        |         | 11 |   |       |     |
|             |                  |                    | 500 times pass/fail        | 20%     | 11 | 0 | 11    | 0   |
|             |                  |                    | 1000 times for info.       |         | 11 |   | 11    | 0   |
|             | Damp Heat        | MIL-STD-202 M103   | 40°C , 95%, 56days         | 20%     | 11 | 0 | 11    | 0   |
|             | (if using epoxy) | or IEC 68-2-3      | or 85°C /85%RH 2,000hrs.   | 20%     | 11 | 0 |       |     |
|             | Cyclic Moisture  | Section 5.23       |                            | 20%     | 11 | 0 | 11    | 0   |
|             | Resistance       |                    |                            |         |    |   |       |     |
| Special     | Internal         | MIL-STD-883        | < 5,000 ppm                | 20%     | 11 | 0 | 11    | 0   |
| Tests       | Moisture         | Method 1018        | water vapor                |         |    |   |       |     |
|             | Flammability     | TR357:Sec. 4.4.2.5 |                            |         |    |   |       | ОК  |
|             | ESD Threshold    | Section 5.22       |                            |         | 6  |   | 6     | 0   |

## 10. Laser Safety

This product uses a semiconductor laser system and is a laser class 1 product acc. FDA, complies with 21CFR1040. 10 and 1040.11. Also this product is a laser class 1 product acc. IEC 825-1.

Class 1 Laser Product

**≜**Caution

If this product is used under conditions not recommended in the specification or this product is used with unauthorized revision, classification for laser product safety standard is invalid. Classify the product again at your responsibility and take appropriate actions.

 $\bigcirc$ 

## 11. Other Precaution

Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed.

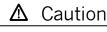
The governmental approval is required to export this product to other countries. To dispose of these components, the appropriate procedure should be taken to prevent illegal exportation.

🛆 Warning

This module must be handled, used and disposed of according to your company's safe working practice.



Be sure to carry out correct soldering for connection to peripheral circuits in order to prevent contact failure or short-circuit. Otherwise, a strong laser beam may cause eye injury, overheating or fire. Do not put this product or components of this product into your mouth. This product contaions material harmful to health.



Be sure to turn the power off when you touch this product connected to the printed circuit boards. Otherwise, electric shock may occur.

Dispose this product or equipment including this product properly as an industrial was teaccording to the regulations.

## 12. Ordering Information

| Ordering Number | Connector type   | Operating Temparature |  |  |  |
|-----------------|--|-----------------------|--|--|--|
| SDM7101-XC      | SC Duplex Connector, Non-metallized.                         | Tc = 0 ~ 70°C         |  |  |  |
| SDM7101-XC-W    | SC Duplex Connector, Nor-metallized.                         | Tc = -40 ~ 85°C       |  |  |  |
| SDM7101-GC-##   | SC Duplex Connector, Metallized. See chart below for detail. |                       |  |  |  |

SDM7101-GC-##

☐ □ Operating Case Temperature Option

N : 0°C ~ -70°C

W : -40°C ~ 85°C

- EMI Shield Finger Option

Z : Without Finger

A ~ E : With Type-A Finger

\*Letter specifies finger position. Refer to Figure2-3 for detail.

## 13. For More Information

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http://www.sei.co.jp/Electro-optic/index.html (SDM7101-XC,SDM7101-XC)